Application No. 10/008,653 Attorney Docket No. 98095DIV4

B. Amendments to the Claims

The following listing of the claims replaces all prior versions and listings of the claims in the application.

Claims 1-16 (Canceled)

17. (Currently Amended) A transistor formed on a substrate assembly, comprising:

a raised drain structure;

a raised source structure;

a gate located between said source and said drain;

a first capping layer in communication with at least a portion of said gate and said source;

a first portion of a gate oxide region in communication with at least a portion of said gate and said source;

a first pocket implant junction located in said substrate assembly, said first pocket implant junction comprising a first high dose dopant implant and defining a first low-resistance path, wherein said first pocket implant junction is in communication with a non-sidewall portion of said source predominantly along a non-sidewall portion thereof and extends under a first portion of said gate;

a second capping layer in communication with at least a portion of said gate and said drain;

a second portion of said gate oxide region in communication with at least a portion of said gate and said drain; and

a second pocket implant junction located in said substrate assembly, said second pocket implant junction comprising a second high dose dopant implant and defining a second low-resistance path, wherein said second pocket implant junction is in communication with a non-sidewall portion of said drain predominantly along a non-sidewall portion thereof and extends under a second portion of said gate.

Claims 18-97 (Canceled)

- 98. (Previously Presented) The transistor of claim 17, wherein said raised source includes doped polysilicon.
- 99. (Previously Presented) The transistor of claim 17, wherein said raised drain includes doped polysilicon.
- 100. (Previously Presented) The transistor of claim 17, wherein said gate includes doped polysilicon.
- 101. (Previously Presented) The transistor of claim 17, wherein said source includes a plug.
- 102. (Previously Presented) The transistor of claim 101, wherein said plug includes an adhesive layer.
- 103. (Previously Presented) The transistor of claim 17, wherein said gate includes a gate terminal.

Application No. 10/008,653 Attorney Docket No. 98095DIV4

Claims 104-124 (Canceled)

125. (Currently Amended) A transistor formed on a substrate assembly, comprising:

a raised drain structure;

a raised source structure;

a gate located between said source and said drain;

a first capping layer in communication with at least a portion of said gate and said source;

a first portion of a gate oxide region in communication with at least a portion of said gate and said source;

a first pocket implant junction located in said substrate assembly, said first pocket implant junction comprising a first high dose dopant implant and defining a first low-resistance path, wherein said first pocket implant junction is in communication with a non-sidewall portion of said source predominantly along a non-sidewall portion thereof and extends under a first portion of said gate;

a first outdiffusion area located in said substrate assembly and extending under at least a portion of said source;

a second capping layer in communication with at least a portion of said gate and said drain;

a second portion of said gate oxide region in communication with at least a portion of said gate and said drain;

a second pocket implant junction located in said substrate assembly; said second pocket implant junction comprising a second high dose dopant implant

and defining a second low-resistance path, wherein said second pocket implant junction is in communication with a non-sidewall portion of said drain predominantly along a non-sidewall portion thereof and extends under a second portion of said gate; and

a second outdiffusion area located in said substrate assembly and extending under at least a portion of said drain.

126. (Previously Presented) The transistor of claim 125, wherein said first and second pocket implant junctions include phosphorous.

Claim 127 (Canceled)

128. (Currently Amended) A transistor formed on a substrate assembly, comprising:

a raised drain structure;

a raised source structure;

a gate located between said source and said drain;

a first capping layer in communication with at least a portion of said gate and said source;

a first portion of a gate oxide region in communication with at least a portion of said gate and said source;

a second capping layer in communication with at least a portion of said gate and said drain;

a second portion of said gate oxide region in communication with at least a portion of said gate and said drain; and

Application No. 10/008,653 Attorney Docket No. 98095DIV4

a halo implant structure located in said substrate assembly, said structure comprising a first pocket implant junction and a second pocket implant junction, wherein said first pocket implant junction includes a first high dose dopant implant in communication with a non-sidewall portion of said source predominantly along a non-sidewall portion thereof and extends under a first edge of said gate, and wherein said second pocket implant junction includes a second high dose dopant implant in communication with a non-sidewall portion of said drain predominantly along a non-sidewall portion thereof and extends under a second edge of said gate.